



Express Mail No. EV331755923US
Attorney Docket No. UMC-96-279
Client/Matter No. 81848.0016.000

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Issued Patent:

Chih-Chien Liu, Ta-Shan Tseng, W. B. Shieh, J.
Y. Wu, Water Lur and Shih-Wei Sun

Patent No.: 6,117,345

Issue Date: September 12, 2000

Serial No. 08/958,460; Filed: October 28, 1997

For: HIGH DENSITY PLASMA CHEMICAL
VAPOR DEPOSITION PROCESS

Group Art Unit: 1112

Examiner: Sergeant, Rabon A.

RECEIVED
NOV 26 2004
TC 1700

CERTIFICATE OF MAILING BY EXPRESS MAIL

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The undersigned hereby certifies that the attached:

1. Information Disclosure Statement;
2. Form PTO/SB/08A, with reference and English translation;
3. Certificate of Mailing; and
4. Return card

relating to the above application, were deposited as "Express Mail" Mailing Label No. EV331755923US, with the United States Postal Service, addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on 27 October 2004.

27 October 2004
Date

10/27/04
Date

Mailer


Peter J. Meza, Reg. No. 32,920
HOGAN & HARTSON LLP
One Tabor Center
1200 17th Street, Suite 1500
Denver, Colorado 80202
(719) 448-5906 Tel
(303) 899-7333 Fax